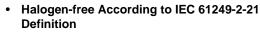


J494-VB Datasheet P-Channel 60 V (D-S) MOSFET

| PRODUCT | SUMMARY | | | |
|---------------------|---|--------------------|-----------------------|--|
| V _{DS} (V) | $R_{DS(on)}$ (Ω) Max. | I _D (A) | Q _g (Typ.) | |
| - 60 | $0.050 \text{ at V}_{GS} = -10 \text{ V}$ | - 30 | 67 | |
| | 0.060 at $V_{GS} = -4.5 \text{ V}$ | - 24 | 07 | |

FEATURES

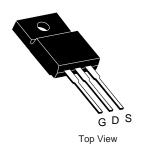


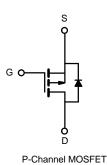


- Trench Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



TO-220 FULLPAK





| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | | | |
|---|-------------------------------------|-----------------------------------|-------------------|------|--|--|--|
| Parameter | | Symbol | Limit | Unit | | | |
| Drain-Source Voltage | V _{DS} | - 60 | V | | | | |
| Gate-Source Voltage | V _{GS} | ± 20 | 7 v | | | | |
| Continuous Drain Current (T _{.I} = 150 °C) | T _C = 25 °C | 1_ | - 30 | | | | |
| Committees Drain Current (1) = 100 C) | T _C = 70 °C | l _D | - 29 | A | | | |
| Pulsed Drain Current (t = 300 μs) | I _{DM} | - 100 | | | | | |
| Avalanche Current | I _{AS} | - 32 | | | | | |
| Single Avalanche Energy ^a L = 0.1 mH | | E _{AS} | 51 | mJ | | | |
| Maximum Power Dissipation ^a | T _C = 25 °C | В | 41.7 ^b | 144 | | | |
| | T _A = 25 °C ^c | $ P_D$ | 2.1 | W | | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | °C | | | |

| THERMAL RESISTANCE RATINGS | | | |
|--|-------------------|-------|------|
| Parameter | Symbol | Limit | Unit |
| Junction-to-Ambient (PCB Mount) ^c | R _{thJA} | 60 | °C/W |
| Junction-to-Case (Drain) | R _{thJC} | 3 | C/VV |

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.c. When mounted on 1" square PCB (FR-4 material).

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|----------------------|---|------|-------|-------|------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{DS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$ | - 60 | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ | - 1 | | - 2.5 | | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 250 | nA | |
| Zero Gate Voltage Drain Current | | V _{DS} = - 60 V, V _{GS} = 0 V | | | - 1 | | |
| | I _{DSS} | V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 125 °C | | | - 50 | μΑ | |
| | | V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 150 °C | | | - 250 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \le -10 \text{ V}, V_{GS} = -10 \text{ V}$ | - 30 | | | Α | |
| Drain-Source On-State Resistance ^a | D | V _{GS} = - 10 V, I _D = - 14 A | | 0.050 | | Ω | |
| | R _{DS(on)} | V _{GS} = - 4.5 V, I _D = - 12 A | | 0.060 | | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 20 V, I _D = - 14 A | | 40 | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | 1765 | | pF | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 \text{ V}, V_{DS} = -20 \text{ V}, f = 1 \text{ MHz}$ | | 230 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 180 | | | |
| Total Gate Charge ^c | Q_g | | | 67 | | nC | |
| Gate-Source Charge ^c | Q_{gs} | V _{DS} = - 20 V, V _{GS} = - 10 V, I _D = - 14 A | | 13.5 | | | |
| Gate-Drain Charge ^c | Q_{gd} | | | 14 | | | |
| Gate Resistance | R_{g} | f = 1 MHz | 0.5 | 2.5 | 5 | Ω | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 10 | 20 | | |
| Rise Time ^c | t _r | $V_{DD} = -20 \text{ V, R}_{L} = 2 \Omega$ | | 11 | 20 | - ns | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong$ - 10 A, V_{GEN} = - 10 V, R_g = 1 Ω | | 42 | 63 | | |
| Fall Time ^c | t _f | | | 12 | 20 | | |
| Drain-Source Body Diode Ratings ar | nd Characteri | stics T _C = 25 °C ^b | | | | | |
| Continuous Current | Is | | | | - 36 | ^ | |
| Pulsed Current | I _{SM} | | | | - 100 | Α | |
| Forward Voltage ^a | V _{SD} | I _F = - 10 A, V _{GS} = 0 V | | - 0.8 | - 1.5 | V | |
| Reverse Recovery Time | t _{rr} | | | 38 | 57 | ns | |
| Peak Reverse Recovery Current | I _{RM(REC)} | I _F = - 10 A, dI/dt = 100 A/μs | | 2.3 | 3.5 | Α | |
| Reverse Recovery Charge | Q _{rr} | 1 | | 40 | 60 | nC | |

Notes:

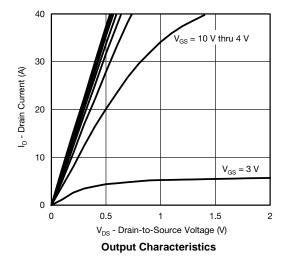
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$ b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

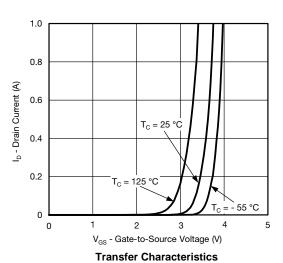
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

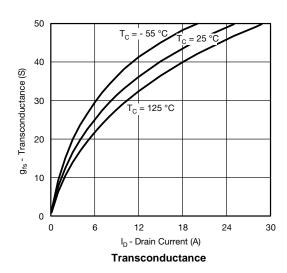
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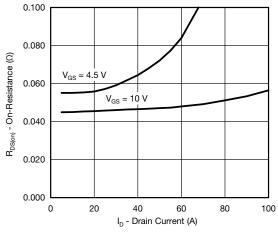


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

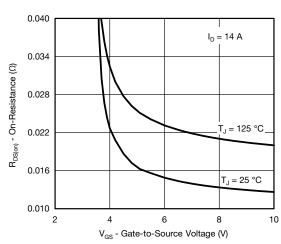




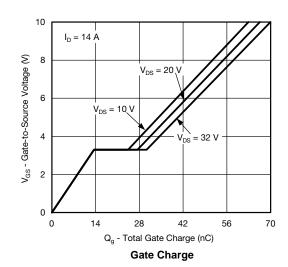




On-Resistance vs. Drain Current



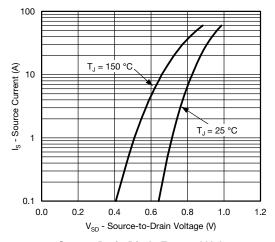
On-Resistance vs. Gate-to-Source Voltage



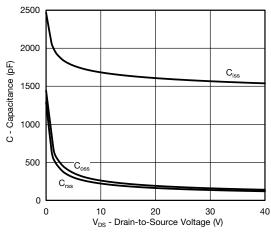
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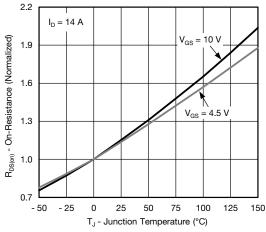
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



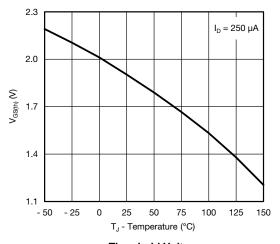
Source-Drain Diode Forward Voltage



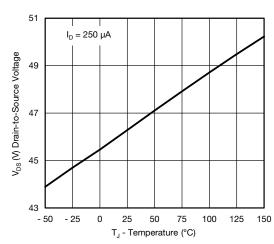
Capacitance



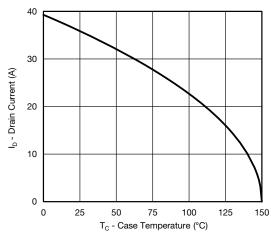
On-Resistance vs. Junction Temperature



Threshold Voltage



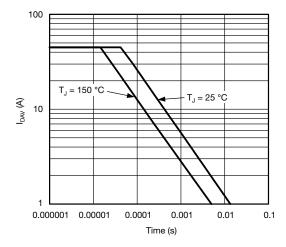
Drain Source Breakdown vs. Junction Temperature

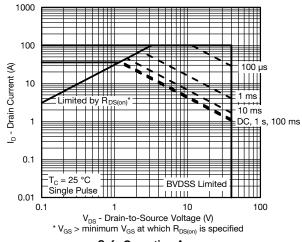


Current Derating



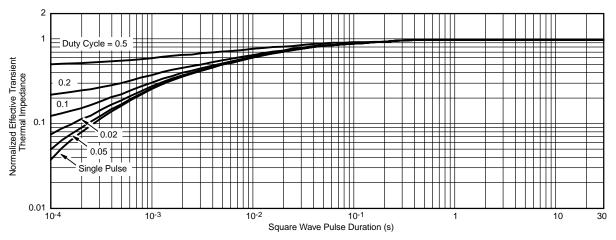
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Single Pulse Avalanche Current Capability vs. Time





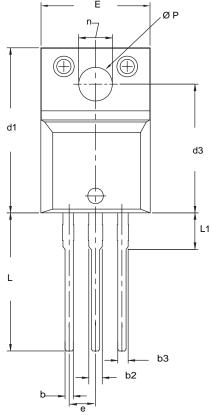
Normalized Thermal Transient Impedance, Junction-to-Case

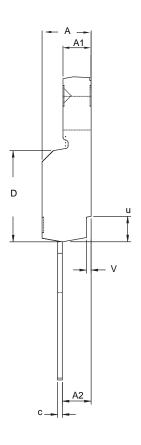
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TO-220 FULLPAK (HIGH VOLTAGE)





| DIM. | MILLIMETERS | | INCHES | |
|------|-------------|--------|-----------|-------|
| | MIN. | MAX. | MIN. | MAX. |
| А | 4.570 | 4.830 | 0.180 | 0.190 |
| A1 | 2.570 | 2.830 | 0.101 | 0.111 |
| A2 | 2.510 | 2.850 | 0.099 | 0.112 |
| b | 0.622 | 0.890 | 0.024 | 0.035 |
| b2 | 1.229 | 1.400 | 0.048 | 0.055 |
| b3 | 1.229 | 1.400 | 0.048 | 0.055 |
| С | 0.440 | 0.629 | 0.017 | 0.025 |
| D | 8.650 | 9.800 | 0.341 | 0.386 |
| d1 | 15.88 | 16.120 | 0.622 | 0.635 |
| d3 | 12.300 | 12.920 | 0.484 | 0.509 |
| E | 10.360 | 10.630 | 0.408 | 0.419 |
| е | 2.54 | BSC | 0.100 BSC | |
| L | 13.200 | 13.730 | 0.520 | 0.541 |
| L1 | 3.100 | 3.500 | 0.122 | 0.138 |
| n | 6.050 | 6.150 | 0.238 | 0.242 |
| ØΡ | 3.050 | 3.450 | 0.120 | 0.136 |
| u | 2.400 | 2.500 | 0.094 | 0.098 |
| V | 0.400 | 0.500 | 0.016 | 0.020 |

ECN: X09-0126-Rev. B, 26-Oct-09 DWG: 5972

- To be used only for process drawing.
 These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads.
 All critical dimensions should C meet C_{pk} > 1.33.
 All dimensions include burrs and plating thickness.
 No chipping or package damage.

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